

Freeform Search

Database:	US Pre-Grant Publication Full-Text Database US Patents Full-Text Database US OCR Full-Text Database EPO Abstracts Database JPO Abstracts Database Derwent World Patents Index IBM Technical Disclosure Bulletins
Term:	16 and silicon ingot <div style="float: right; text-align: right;"> <input type="button" value="Up"/> <input type="button" value="Down"/> </div>
Display:	<input type="text" value="10"/> Documents in Display Format: <input type="text" value="-"/> Starting with Number <input type="text" value="1"/>
Generate: <input type="radio"/> Hit List <input checked="" type="radio"/> Hit Count <input type="radio"/> Side by Side <input type="radio"/> Image	

Search History

DATE: Thursday, January 19, 2006 [Printable Copy](#) [Create Case](#)

<u>Set</u> <u>Name</u>	<u>Query</u>	<u>Hit</u> <u>Count</u>	<u>Set</u> <u>Name</u> result set
<i>DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ</i>			
<u>L9</u>	16 and silicon ingot	1	<u>L9</u>
<u>L8</u>	L5 and silicon ingot	17	<u>L8</u>
<u>L7</u>	15 and abrasive same amine same (hydroxide or koh or naoh) and ph	122	<u>L7</u>
<u>L6</u>	15 and abrasive same amine same(hydroxide or koh or naoh) and ph	122	<u>L6</u>
<u>L5</u>	(cutting or lapping or polishing or slicing) and abrasive and amine and (hydroxide or koh or naoh) and ph	2203	<u>L5</u>
<u>L4</u>	13 and ph	2	<u>L4</u>
<u>L3</u>	L2 and (hydroxide or koh or naoh or base or basic)	4	<u>L3</u>
<u>L2</u>	L1 and amine	4	<u>L2</u>
<u>L1</u>	silicon ingot same cutting same slurry	48	<u>L1</u>

END OF SEARCH HISTORY